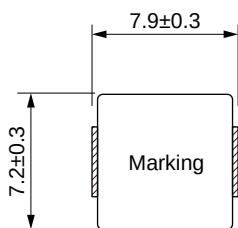
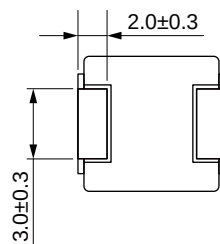


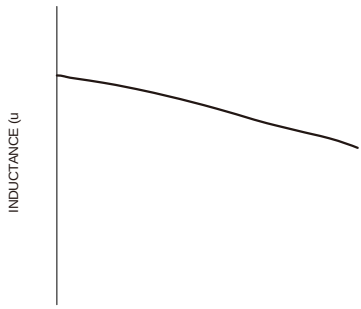
Dimensions: [mm]



Land Pattern: [mm]



Electrical Properties:



Soldering Reflow:

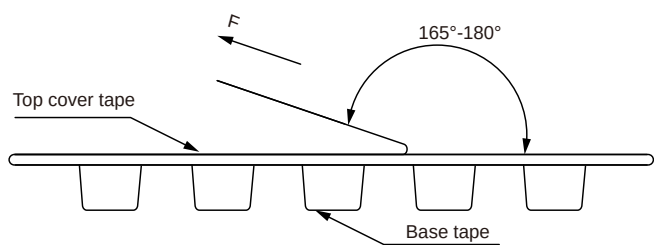
Preheat condition: 150 ~200℃ / 60~120 sec.
Allowed time above 217℃ : 60~150 sec.
Max temperature: 260℃ .

Allowed Reflow time: 2x max.

Packaging Information:

Tape Dimension :

Peel force of top cover tape:

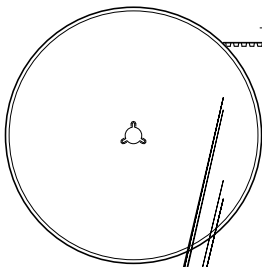


The peel force of top cover tape shall be between 0.1 to 1.3 N

Product Marking:

Marking	K+Printing (Inductance+period)
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Reel Dimension: [mm]



Cover Tape
Embossed Carrier

Packaging Quantity:

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